



Product Change Notification

107895 – 01

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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Product Change Notification

Change Notification #: 107895 - 01
Change Title: Intel® Optical Transceiver
TXN174114015xxx, PCN 107895-01,
Manufacturing Site Change. Reason for
Revision: Order Code Change, Added New
End Cap and Packaging Box.
Date of Publication: October 31, 2007

Key Characteristics of the Change:

Manufacturing Change
Order Code Change
End Cap and Packaging Box Change

Forecasted Key Milestones:

Date of Samples Availability:	Dec 24, 2007
Date of Qualification Data Availability:	Nov 15, 2007
Date Customer Must be Ready to Receive Post-Conversion Material:	Dec 24, 2007
Date of First Availability of Post-Conversion Material:	Dec 24/2007

The date of "First Availability of Post-Conversion Material" is the projected date that a customer may expect to receive the Post-Conversion Materials. This date is determined by the projected depletion of inventory at the time of the PCN publication. The depletion of inventory may be impacted by fluctuating supply and demand, therefore, although customers should be prepared to receive the Post-Converted Materials on this date, Intel will continue to ship and customers may continue to receive the pre-converted materials until the inventory has been depleted.

Description of Change to the Customer:

Reason for Revision: Changed Order Code, Added New End Cap and Packaging Box.

Contract Manufacturer Transfer

The TXN174114015xxx has a new transponder CM assembly site in Bangkok, Thailand and the specific customer order code and Material Master number(MM#) will change to reflect the new site. The previous assembly site for the TXN174114015 was in Penang, Malaysia.

New End Cap

To enhance the end cap design used on the TXN174114015, Intel will replace the two single end caps for each Tx and Rx port with one end cap for both ports.

New Packaging Box

Intel will use a new packaging box to accommodate the new end cap design and reduce overall packaging box size.

Customer Impact of Change and Recommended Action:

Intel will perform full quality and reliability testing, including 2000 hours testing, and complete design verification testing for TXN174114015xxx to ensure that there is no quality, reliability or functional implications to our customers. The qualification reports for TXN174114015xxx will be available on Nov 15, 2007. Please contact your local Intel sales representative to request the qualification reports.

First samples of the TXN174114015xxx with changes will not be made available unless specifically requested by the customer.

Intel will change the Material Master ID # (MM#) for TXN174114015 with this PCN change. Please refer to the chart below for the updated MM#.

Products Affected / Intel Ordering Codes:

Affected Product Code	Pre Change MM#	Post-Affected Product Code	Post Change MM#
TXN174114015F20	878275	TXN174114015FX1	892652
TXN174114015F22	882005	TXN174114015FX4	892654
TXN174114015F24	881415	TXN174114015FX5	892655
TXN174114015F25	882006	TXN174114015FX6	892656
TXN174114015F27	882007	TXN174114015FX9	892657
TXN174114015F36	882281	TXN174114015FXA	892666
TXN174114015F28	882009	TXN174114015FX8	892658

Reference Documents / Attachments:

Document:

Location #:

PCN Revision History:

Date of Revision:

Revision Number:

Reason:

September 30, 2007

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Originally Published PCN

October 31, 2007

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Change order code and add end cap and new packaging box